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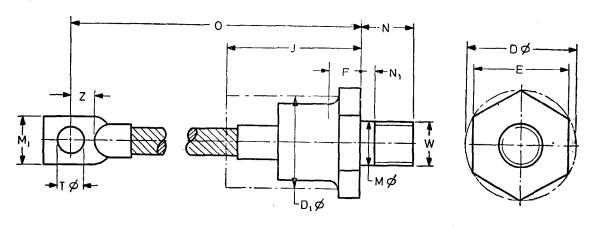


Indian Standard

DIMENSIONS OF SEMICONDUCTOR DEVICES DEVICE OUTLINE OD33

1. Dimensions

Note — This drawing has been prepared in accordance with IS: 5001 (Part I) - 1969 'Guide for the preparation of drawings of semiconductor devices and integrated circuits: Part I Semiconductor devices' and IS: 5001 (Part II) - 1973 'Guide for the preparation of drawings of semiconductor devices and integrated circuits: Part II Integrated circuits'.



Reference	}	N		
	Min	Nom	Max	Notes
φ D		~	37.0	
φ D1		-	32	2,1
E _.		32		_
F	7			
J			82	1,3
φ M		_	See Note 4	4
M_1	-		22	5
N 1	_	_	4	_
0	135		165	_
φ <i>T</i>	-	See Note 6	_	6
Z		See Note 7		7

Ref	f Туре A		Туре В			Type C			
	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max
/	12		14	19	_	21	19		21
w	_	_	M16	_	_	M16			M16 x 1

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- Note 1 The device, with the exception of the hexagon, thread and flexible terminal, lies within the cylinder of diameter D_1 and length J.
 - Note 2 Diameter Di must not be greater than the actual across flat dimensions of the hexagon used,
 - Note 3 Dimension J is the seated height with the terminal bent at right angles.
- Note 4 Diameter M refers to zone N_1 . The maximum value should not exceed the outside diameter of the thread.
 - Note 5 The contour and orientation of the terminal lug are undefined.
 - Note 6 Clearance hole for M8 or M10 bolt.
 - Note 7 Minimum flat of 8 mm or 10 mm for M8 or M10 bolt respectively.

Country or Organization	Code					
- Committee of the comm	Type A	Туре В	Туре С			
IEC	A15MA	A15MB	A15MC			
Germany	106A2	-	106B2			
France	_	F50M				
USSR	KD5P1	_				
Japan	SC-44A		SC-44B			

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